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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	16
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.25V
Data Converters	A/D 16x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	20-VFQFN Exposed Pad
Supplier Device Package	20-QFN (4x4)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/silicon-labs/c8051f530-c-imr">https://www.e-xfl.com/product-detail/silicon-labs/c8051f530-c-imr</a>

# C8051F52x/F52xA/F53x/F53xA

includes software with a developer's studio and debugger, a USB debug adapter, a target application board with the associated MCU installed, and the required cables and wall-mount power supply. The development kit requires a computer with Windows installed. As shown in Figure 1.5, the PC is connected to the USB debug adapter. A six-inch ribbon cable connects the USB debug adapter to the user's application board, picking up the two C2 pins and GND.

The Silicon Laboratories IDE interface is a vastly superior developing and debugging configuration, compared to standard MCU emulators that use on-board "ICE Chips" and require the MCU in the application board to be socketed. Silicon Laboratories' debug paradigm increases ease of use and preserves the performance of the precision analog peripherals.

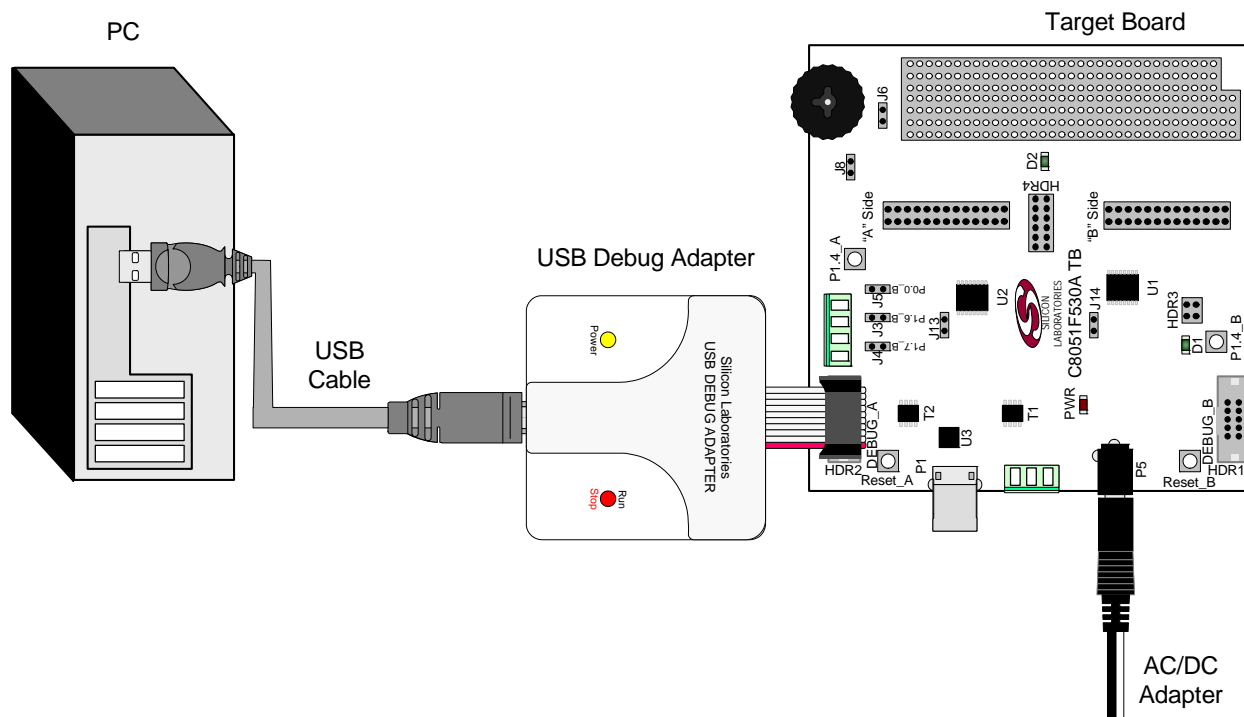


Figure 1.5. Development/In-System Debug Diagram

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## 2.2. Electrical Characteristics

**Table 2.2. Global DC Electrical Characteristics**

–40 to +125 °C, 25 MHz System Clock unless otherwise specified. Typical values are given at 25 °C

Parameter	Conditions	Min	Typ	Max	Units
Supply Input Voltage ( $V_{\text{REGIN}}$ ) <sup>1</sup>	Output Current $\leq 1$ mA				
	C8051F52x/53x	2.7	—	5.25	V
	C8051F52xA/53xA	1.8 <sup>1</sup>	—	5.25	V
	C8051F52x-C/53x-C	2.0 <sup>1</sup>	—	5.25	V
Digital Supply Voltage ( $V_{\text{DD}}$ )	C8051F52x/53x	2.0	—	2.7	V
	C8051F52xA/53xA	1.8	—	2.7	V
	C8051F52x-C/53x-C	2.0	—	2.75	V
Core Supply RAM Data Retention Voltage		—	1.5	—	V
SYSCLK (System Clock) <sup>2</sup>		0	—	25	MHz
Specified Operating Temperature Range		–40	—	+125	°C
Digital Supply Current—CPU Active (Normal Mode, fetching instructions from Flash)					
$I_{\text{DD}}$ <sup>3,4</sup>	<b><math>V_{\text{DD}} = 2.1</math> V:</b>				
	Clock = 32 kHz	—	13	—	$\mu\text{A}$
	Clock = 200 kHz	—	60	—	$\mu\text{A}$
	Clock = 1 MHz	—	0.28	—	mA
	Clock = 25 MHz	—	5.1	9	mA
	<b><math>V_{\text{DD}} = 2.6</math> V:</b>				
	Clock = 32 kHz	—	22	—	$\mu\text{A}$
	Clock = 200 kHz	—	105	—	$\mu\text{A}$
	Clock = 1 MHz	—	0.5	—	mA
	Clock = 25 MHz	—	7.3	13	mA
$I_{\text{DD}}$ Frequency Sensitivity <sup>3,5</sup>	T = 25 °C:				
	$V_{\text{DD}} = 2.1$ V, F $\leq 12$ MHz	—	0.276	—	mA/MHz
	$V_{\text{DD}} = 2.1$ V, F > 12 MHz	—	0.140	—	mA/MHz
	$V_{\text{DD}} = 2.6$ V, F $\leq 12$ MHz	—	0.424	—	mA/MHz
	$V_{\text{DD}} = 2.6$ V, F > 12 MHz	—	0.184	—	mA/MHz

### Notes:

- For more information on  $V_{\text{REGIN}}$  characteristics, see Table 2.6 on page 30.
- SYSCLK must be at least 32 kHz to enable debugging.
- Based on device characterization data; Not production tested.
- Does not include internal oscillator or internal regulator supply current.
- $I_{\text{DD}}$  can be estimated for frequencies  $\leq 12$  MHz by multiplying the frequency of interest by the frequency sensitivity number for that range. When using these numbers to estimate  $I_{\text{DD}} > 12$  MHz, the estimate should be the current at 25 MHz minus the difference in current indicated by the frequency sensitivity number. For example:  $V_{\text{DD}} = 2.6$  V; F = 20 MHz,  $I_{\text{DD}} = 7.3$  mA – (25 MHz – 20 MHz)  $\times$  0.184 mA/MHz = 6.38 mA.
- Idle  $I_{\text{DD}}$  can be estimated for frequencies  $\leq 1$  MHz by multiplying the frequency of interest by the frequency sensitivity number for that range. When using these numbers to estimate  $I_{\text{DD}} > 1$  MHz, the estimate should be the current at 25 MHz minus the difference in current indicated by the frequency sensitivity number. For example:  $V_{\text{DD}} = 2.6$  V; F = 5 MHz, Idle  $I_{\text{DD}} = 3$  mA – (25 MHz – 5 MHz)  $\times$  118  $\mu\text{A}/\text{MHz}$  = 0.64 mA.

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**Table 2.4. Temperature Sensor Electrical Characteristics**

$V_{DD} = 2.1\text{ V}$ ,  $V_{REF} = 1.5\text{ V}$  (REFSL=0),  $-40$  to  $+125\text{ }^{\circ}\text{C}$  unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Linearity <sup>1</sup>		—	0.1	—	$^{\circ}\text{C}$
Gain <sup>1</sup>		—	3.33	—	$\text{mV}/^{\circ}\text{C}$
Gain Error <sup>2</sup>		—	$\pm 100$	—	$\mu\text{V}/^{\circ}\text{C}$
Offset <sup>1</sup>	Temp = $0\text{ }^{\circ}\text{C}$	—	890	—	mV
Offset Error <sup>2</sup>	Temp = $0\text{ }^{\circ}\text{C}$	—	$\pm 15$	—	mV
Tracking Time		12	—	—	$\mu\text{s}$
Power Supply Current		—	17	—	$\mu\text{A}$

**Notes:**

1. Includes ADC offset, gain, and linearity variations.
2. Represents one standard deviation from the mean.

**Table 2.5. Voltage Reference Electrical Characteristics**

$V_{DD} = 2.1\text{ V}$ ;  $-40$  to  $+125\text{ }^{\circ}\text{C}$  unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
<b>Internal Reference (REFBE = 1)</b>					
Output Voltage	$I_{DD} \approx 1\text{ mA}$ ; No load on VREF pin and all other GPIO pins. 25 $^{\circ}\text{C}$ ambient (REFLV = 0) 25 $^{\circ}\text{C}$ ambient (REFLV = 1), $V_{DD} = 2.6\text{ V}$	1.45 2.15	1.5 2.2	1.55 2.25	V
$V_{REF}$ Short-Circuit Current		—	2.5	—	mA
$V_{REF}$ Temperature Coefficient		—	33	—	$\text{ppm}/^{\circ}\text{C}$
Load Regulation	Load = 0 to 200 $\mu\text{A}$ to GND	—	10	—	$\text{ppm}/\mu\text{A}$
$V_{REF}$ Turn-on Time 1	4.7 $\mu\text{F}$ , 0.1 $\mu\text{F}$ bypass	—	21	—	ms
$V_{REF}$ Turn-on Time 2	0.1 $\mu\text{F}$ bypass	—	230	—	$\mu\text{s}$
Power Supply Rejection		—	2.1	—	$\text{mV}/\text{V}$
<b>External Reference (REFBE = 0)</b>					
Input Voltage Range		0	—	$V_{DD}$	V
Input Current	Sample Rate = 200 ksps; $V_{REF} = 1.5\text{ V}$	—	2.4	—	$\mu\text{A}$
<b>Bias Generators</b>					
ADC Bias Generator	BIASE = 1	—	22	—	$\mu\text{A}$
Power Consumption (Internal)		—	35	—	$\mu\text{A}$

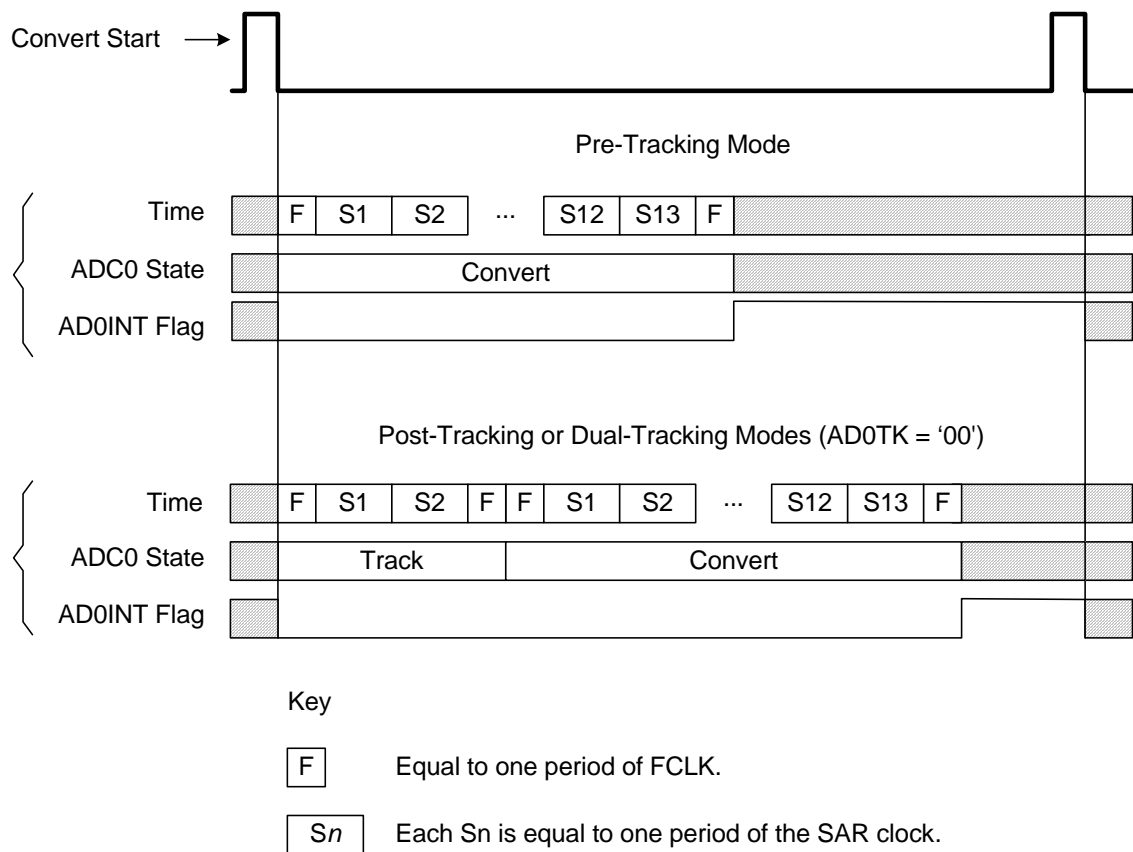


Figure 4.4. 12-Bit ADC Tracking Mode Example

## SFR Definition 4.9. ADC0TK: ADC0 Tracking Mode Select

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
AD0PWR				AD0TM		AD0TK		11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
						(bit addressable)		0xBA

**Bits7–4: AD0PWR3–0:** ADC0 Burst Power-Up Time.  
 For BURSTEN = 0:  
 ADC0 power state controlled by AD0EN.  
 For BURSTEN = 1 and AD0EN = 1;  
 ADC0 remains enabled and does not enter the very low power state.  
 For BURSTEN = 1 and AD0EN = 0:  
 ADC0 enters the very low power state as specified in Table 2.3 on page 28 and is enabled after each convert start signal. The Power Up time is programmed according to the following equation:

$$AD0PWR = \frac{T_{startup}}{200ns} - 1 \quad \text{or} \quad T_{startup} = (AD0PWR + 1)200ns$$

**Bits3–2: AD0TM1–0:** ADC0 Tracking Mode Select Bits.  
 00: Reserved.  
 01: ADC0 is configured to Post-Tracking Mode.  
 10: ADC0 is configured to Pre-Tracking Mode.  
 11: ADC0 is configured to Dual-Tracking Mode (default).

**Bits1–0: AD0TK1–0:** ADC0 Post-Track Time.  
 Post-Tracking time is controlled by AD0TK as follows:  
 00: Post-Tracking time is equal to 2 SAR clock cycles + 2 FCLK cycles.  
 01: Post-Tracking time is equal to 4 SAR clock cycles + 2 FCLK cycles.  
 10: Post-Tracking time is equal to 8 SAR clock cycles + 2 FCLK cycles.  
 11: Post-Tracking time is equal to 16 SAR clock cycles + 2 FCLK cycles.

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## SFR Definition 10.2. IP: Interrupt Priority

R	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	PSPI0	PT2	PS0	PT1	PX1	PT0	PX0	10000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Bit Addressable
SFR Address: 0xB8								
<b>Bit7:</b> <b>UNUSED.</b> Read = 1b; Write = don't care.								
<b>Bit6:</b> <b>PSPI0:</b> Serial Peripheral Interface (SPI0) Interrupt Priority Control. This bit sets the priority of the SPI0 interrupt. 0: SPI0 interrupt set to low priority level. 1: SPI0 interrupt set to high priority level.								
<b>Bit5:</b> <b>PT2:</b> Timer 2 Interrupt Priority Control. This bit sets the priority of the Timer 2 interrupt. 0: Timer 2 interrupt set to low priority level. 1: Timer 2 interrupt set to high priority level.								
<b>Bit4:</b> <b>PS0:</b> UART0 Interrupt Priority Control. This bit sets the priority of the UART0 interrupt. 0: UART0 interrupt set to low priority level. 1: UART0 interrupt set to high priority level.								
<b>Bit3:</b> <b>PT1:</b> Timer 1 Interrupt Priority Control. This bit sets the priority of the Timer 1 interrupt. 0: Timer 1 interrupt set to low priority level. 1: Timer 1 interrupt set to high priority level.								
<b>Bit2:</b> <b>PX1:</b> External Interrupt 0 Priority Control. This bit sets the priority of the external interrupt 1. 0: INT1 interrupt set to low priority level. 1: INT1 interrupt set to high priority level.								
<b>Bit1:</b> <b>PT0:</b> Timer 0 Interrupt Priority Control. This bit sets the priority of the Timer 0 interrupt. 0: Timer 0 interrupt set to low priority level. 1: Timer 0 interrupt set to high priority level.								
<b>Bit0:</b> <b>PX0:</b> External Interrupt 0 Priority Control. This bit sets the priority of the external interrupt 0. 0: INT0 interrupt set to low priority level. 1: INT0 interrupt set to high priority level.								

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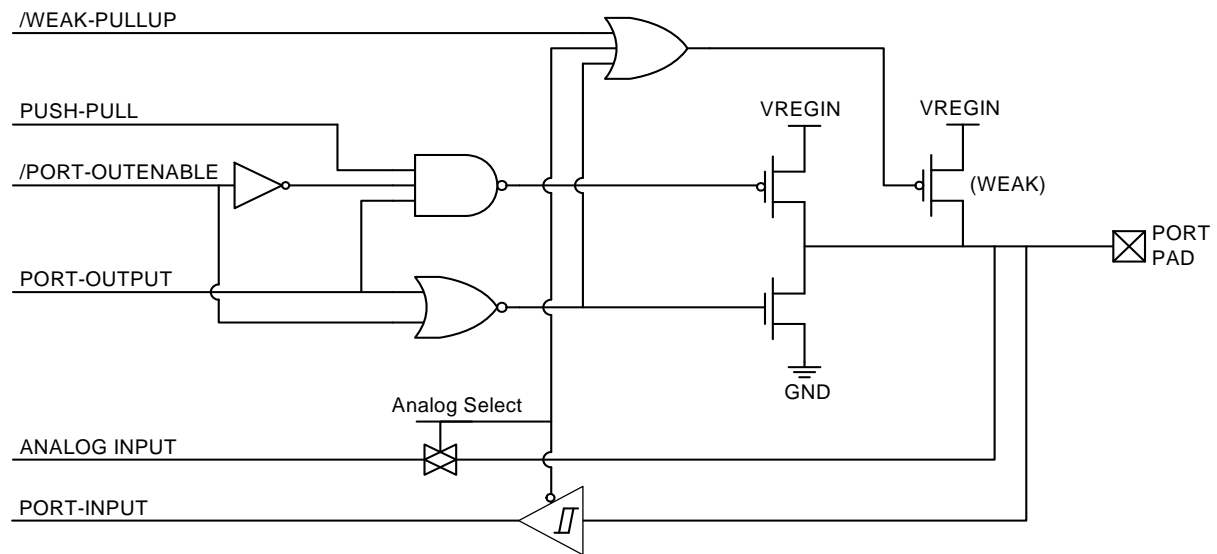
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## 11.8. Software Reset

Software may force a reset by writing a 1 to the SWRSF bit (RSTSRC.4). The SWRSF bit will read 1 following a software forced reset. The state of the RST pin is unaffected by this reset.



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### Figure 13.2. Port I/O Cell Block Diagram

**Important Note:** The SPI can be operated in either 3-wire or 4-wire modes, depending on the state of the NSSMD1–NSSMD0 bits in register SPI0CN. According to the SPI mode, the NSS signal may or may not be routed to a Port pin.

## 13.2. Port I/O Initialization

Port I/O initialization consists of the following steps:

1. Select the input mode (analog or digital) for all Port pins, using the Port Input Mode register (PnMDIN).
2. Select the output mode (open-drain or push-pull) for all Port pins, using the Port Output Mode register (PnMDOUT).
3. Select any pins to be skipped by the I/O Crossbar using the Port Skip registers (PnSKIP).
4. Assign Port pins to desired peripherals using the XBRn registers.
5. Enable the Crossbar (XBARE = 1).

All Port pins must be configured as either analog or digital inputs. Any pins to be used as Comparator or ADC inputs should be configured as analog inputs. When a pin is configured as an analog input, its weak pullup, digital driver, and digital receiver are disabled. This process saves power and reduces noise on the analog input. Pins configured as digital inputs may still be used by analog peripherals; however, this practice is not recommended.

Additionally, all analog input pins should be configured to be skipped by the Crossbar (accomplished by setting the associated bits in PnSKIP). Port input mode is set in the PnMDIN register, where a 1 indicates a digital input, and a 0 indicates an analog input. All pins default to digital inputs on reset. See SFR Definition 13.4 for the PnMDIN register details.

**Important Note:** Port 0 and Port 1 pins are 5.25 V tolerant across the operating range of  $V_{\text{REGIN}}$ .

The output driver characteristics of the I/O pins are defined using the Port Output Mode registers (PnMDOUT). Each Port Output driver can be configured as either open drain or push-pull. This selection is required even for the digital resources selected in the XBRn registers, and is not automatic. When the WEAKPUD bit in XBR1 is 0, a weak pullup is enabled for all Port I/O configured as open-drain. WEAKPUD does not affect the push-pull Port I/O. Furthermore, the weak pullup is turned off on an output that is driving a 0 and for pins configured for analog input mode to avoid unnecessary power dissipation.

Registers XBR0 and XBR1 must be loaded with the appropriate values to select the digital I/O functions required by the design. Setting the XBARE bit in XBR1 to 1 enables the Crossbar. Until the Crossbar is enabled, the external pins remain as standard Port I/O (in input mode), regardless of the XBRn Register settings. For given XBRn Register settings, one can determine the I/O pin-out using the Priority Decode Table.

The Crossbar must be enabled to use Port pins as standard Port I/O in output mode. **Port output drivers are disabled while the Crossbar is disabled.**

## SFR Definition 13.2. XBR1: Port I/O Crossbar Register 1

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
WEAKPUD	XBARE	T1E	T0E	ECIE	Reserved	PCA0ME		00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
SFR Address: 0xE2								
<b>Bit7:</b> <b>WEAKPUD:</b> Port I/O Weak Pullup Disable. 0: Weak Pullups enabled (except for Ports whose I/O are configured as analog input). 1: Weak Pullups disabled.								
<b>Bit6:</b> <b>XBARE:</b> Crossbar Enable. 0: Crossbar disabled. 1: Crossbar enabled.								
<b>Bit5:</b> <b>T1E:</b> T1 Enable 0: T1 unavailable at Port pin. 1: T1 routed to Port pin.								
<b>Bit4:</b> <b>T0E:</b> T0 Enable 0: T0 unavailable at Port pin. 1: T0 routed to Port pin.								
<b>Bit3:</b> <b>ECIE:</b> PCA0 External Counter Input Enable 0: ECI unavailable at Port pin. 1: ECI routed to Port pin.								
<b>Bit2:</b> <b>Reserved.</b> Must Write 0b.								
<b>Bits1–0:</b> <b>PCA0ME:</b> PCA Module I/O Enable Bits. 00: All PCA I/O unavailable at Port pins. 01: CEX0 routed to Port pin. 10: CEX0, CEX1 routed to Port pins. 11: CEX0, CEX1, CEX2 routed to Port pins.								

## 13.3. General Purpose Port I/O

Port pins that remain unassigned by the Crossbar and are not used by analog peripherals can be used for general purpose I/O. Ports P0–P1 are accessed through corresponding special function registers (SFRs) that are both byte addressable and bit addressable. When writing to a Port, the value written to the SFR is latched to maintain the output data value at each pin. When reading, the logic levels of the Port's input pins are returned regardless of the XBRn settings (i.e., even when the pin is assigned to another signal by the Crossbar, the Port register can always read its corresponding Port I/O pin). The exception to this is the execution of the read-modify-write instructions that target a Port Latch register as the destination. The read-modify-write instructions when operating on a Port SFR are the following: ANL, ORL, XRL, JBC, CPL, INC, DEC, DJNZ and MOV, CLR or SETB, when the destination is an individual bit in a Port SFR. For these instructions, the value of the latch register (not the pin) is read, modified, and written back to the SFR.

## SFR Definition 15.2. SBUF0: Serial (UART0) Port Data Buffer

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
SFR Address: 0x99								

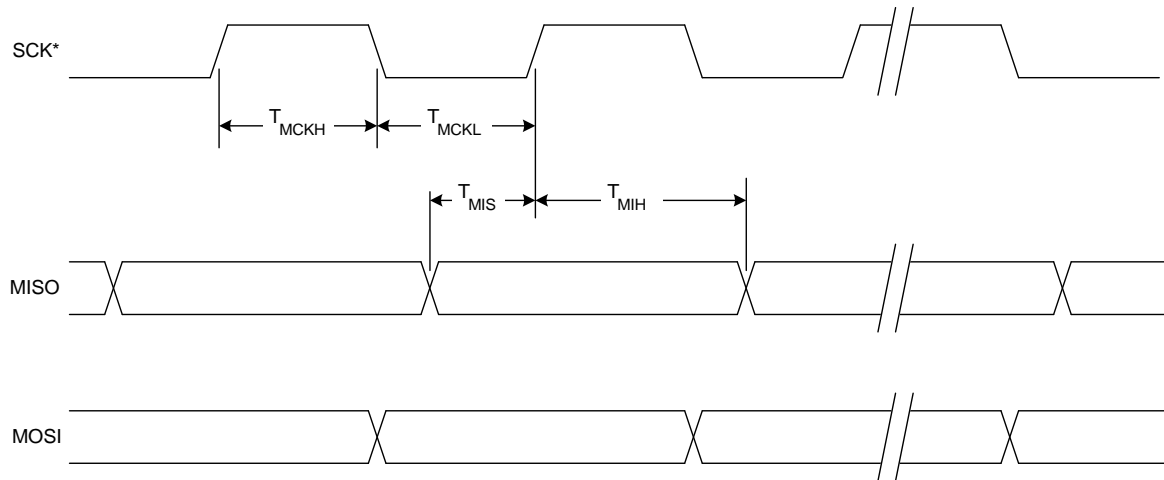
**Bits7–0: SBUF0[7:0]:** Serial Data Buffer Bits 7–0 (MSB–LSB)  
 This SFR accesses two registers; a transmit shift register and a receive latch register. When data is written to SBUF0, it goes to the transmit shift register and is held for serial transmission. Writing a byte to SBUF0 initiates the transmission. A read of SBUF0 returns the contents of the receive latch.

**Table 15.1. Timer Settings for Standard Baud Rates Using the Internal Oscillator**

Frequency: 24.5 MHz							
	Target Baud Rate (bps)	Baud Rate % Error	Oscillator Divide Factor	Timer Clock Source	SCA1–SCA0 (pre-scale select)*	T1M*	Timer 1 Reload Value (hex)
SYSCLK from Internal Osc.	230400	–0.32%	106	SYSCLK	XX	1	0xCB
	115200	–0.32%	212	SYSCLK	XX	1	0x96
	57600	0.15%	426	SYSCLK	XX	1	0x2B
	28800	–0.32%	848	SYSCLK / 4	01	0	0x96
	14400	0.15%	1704	SYSCLK / 12	00	0	0xB9
	9600	–0.32%	2544	SYSCLK / 12	00	0	0x96
	2400	–0.32%	10176	SYSCLK / 48	10	0	0x96
	1200	0.15%	20448	SYSCLK / 48	10	0	0x2B

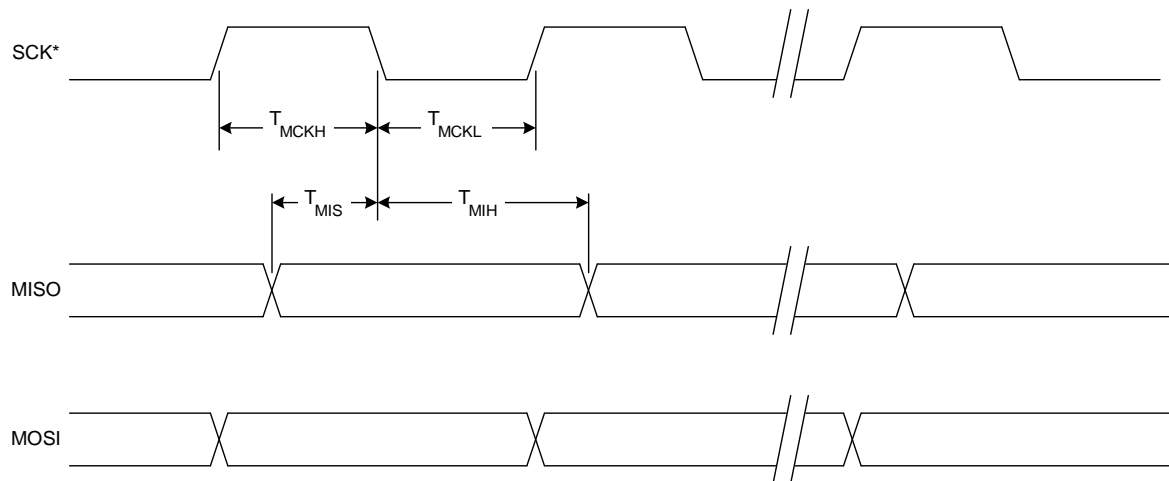
X = Don't care

**Note:** SCA1–SCA0 and T1M bit definitions can be found in Section 18.1.



\* SCK is shown for CKPOL = 0. SCK is the opposite polarity for CKPOL = 1.

**Figure 16.6. SPI Master Timing (CKPHA = 0)**



\* SCK is shown for CKPOL = 0. SCK is the opposite polarity for CKPOL = 1.

**Figure 16.7. SPI Master Timing (CKPHA = 1)**

## 17.4. LIN Slave Mode Operation

When the device is configured for slave mode operation, it must wait for a command from a master node. Access from the firmware to data buffer and ID registers of the LIN peripheral is only possible when a data request is pending (DTREQ bit (LIN0ST.4) is 1) and also when the LIN bus is not active (ACTIVE bit (LIN0ST.7) is set to 0).

The LIN peripheral in slave mode detects the header of the message frame sent by the LIN master. If slave synchronization is enabled (autobaud), the slave synchronizes its internal bit time to the master bit time.

The LIN peripheral configured for slave mode will generate an interrupt in one of three situations:

1. After the reception of the IDENTIFIER FIELD.
2. When an error is detected.
3. When the message transfer is completed.

The application should perform the following steps when an interrupt is detected:

1. Check the status of the DTREQ bit (LIN0ST.4). This bit is set when the IDENTIFIER FIELD has been received.
2. If DTREQ (LIN0ST.4) is set, read the identifier from LIN0ID and process it. If DTREQ (LIN0ST.4) is not set, continue to step 7.
3. Set the TXRX bit (LIN0CTRL.5) to 1 if the current frame is a transmit operation for the slave and set to 0 if the current frame is a receive operation for the slave.
4. Load the data length into LIN0SIZE.
5. For a slave transmit operation, load the data to transmit into the data buffer.
6. Set the DTACK bit (LIN0CTRL.4). Continue to step 10.
7. If DTREQ (LIN0ST.4) is not set, check the DONE bit (LIN0ST.0). The transmission was successful if the DONE bit is set.
8. If the transmission was successful and the current frame was a receive operation for the slave, load the received data bytes from the data buffer.
9. If the transmission was not successful, check LIN0ERR to determine the nature of the error. Further error handling has to be done by the application.
10. Set the RSTINT (LIN0CTRL.3) and RSTERR bits (LIN0CTRL.2) to reset the interrupt request and the error flags.

In addition to these steps, the application should be aware of the following:

1. If the current frame is a transmit operation for the slave, steps 1 through 5 must be completed during the IN-FRAME RESPONSE SPACE. If it is not completed in time, a timeout will be detected by the master.
2. If the current frame is a receive operation for the slave, steps 1 through 5 have to be finished until the reception of the first byte after the IDENTIFIER FIELD. Otherwise, the internal receive buffer of the LIN peripheral will be overwritten and a timeout error will be detected in the LIN peripheral.
3. The LIN module does not directly support LIN Version 1.3 Extended Frames. If the application detects an unknown identifier (e.g. extended identifier), it has to write a 1 to the STOP bit (LIN0CTRL.7) instead of setting the DTACK (LIN0CTRL.4) bit. At that time, steps 2 through 5 can then be skipped. In this situation, the LIN peripheral stops the processing of the LIN communication until the next SYNC BREAK is received.
4. Changing the configuration of the checksum during a transaction will cause the interface to reset and the transaction to be lost. To prevent this, the checksum should not be configured while a transaction is

## 17.7. LIN Registers

The following Special Function Registers (SFRs) are available:

### 17.7.1. LIN Direct Access SFR Registers Definition

#### SFR Definition 17.1. LINADDR: Indirect Address Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
SFR Address: 0x92								
<b>Bit7–0: LINADDR7-0:</b> LIN Indirect Address Register Bits. This register hold an 8-bit address used to indirectly access the LIN0 core registers. Table 17.4 lists the LIN0 core registers and their indirect addresses. Reads and writes to LINDATA will target the register indicated by the LINADDR bits.								

#### SFR Definition 17.2. LINDATA: LIN Data Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
SFR Address: 0x93								
<b>Bit7–0: LINDATA7-0:</b> LIN Indirect Data Register Bits. When this register is read, it will read the contents of the LIN0 core register pointed to by LINADDR. When this register is written, it will write the value to the LIN0 core register pointed to by LINADDR.								

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## 17.7.2. LIN Indirect Access SFR Registers Definition

**Table 17.4. LIN Registers\* (Indirectly Addressable)**

Name	Address	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
LIN0DT1	0x00	DATA1[7:0]							
LIN0DT2	0x01	DATA2[7:0]							
LIN0DT3	0x02	DATA3[7:0]							
LIN0DT4	0x03	DATA4[7:0]							
LIN0DT5	0x04	DATA5[7:0]							
LIN0DT6	0x05	DATA6[7:0]							
LIN0DT7	0x06	DATA7[7:0]							
LIN0DT8	0x07	DATA8[7:0]							
LIN0CTRL	0x08	STOP(s)	SLEEP(s)	TXRX	DTACK(s)	RSTINT	RSTERR	WUPREQ	STREQ(m)
LIN0ST	0x09	ACTIVE	IDLTOUT	ABORT(s)	DTREQ(s)	LININT	ERROR	WAKEUP	DONE
LIN0ERR	0x0A				SYNCH(s)	PRTY(s)	TOUT	CHK	BITERR
LIN0SIZE	0x0B	ENHCHK				LINSIZE[3:0]			
LIN0DIV	0x0C	DIVLSB[7:0]							
LIN0MUL	0x0D	PRESCL[1:0]		LINMUL[4:0]					DIV9
LIN0ID	0x0E			ID[5:0]					

\*These registers are used in both master and slave mode. The register bits marked with (m) are accessible only in Master mode while the register bits marked with (s) are accessible only in slave mode. All other registers are accessible in both modes.

## SFR Definition 17.4. LIN0DT1: LIN0 Data Byte 1

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
								Address: 0x00 (indirect)
<b>Bit7–0:</b> <b>LIN0DT1:</b> LIN Data Byte 1. Serial Data Byte 1 that is received or transmitted across the LIN interface.								



## 18.2. Timer 2

Timer 2 is a 16-bit timer formed by two 8-bit SFRs: TMR2L (low byte) and TMR2H (high byte). Timer 2 may operate in 16-bit auto-reload mode or (split) 8-bit auto-reload mode. The T2SPLIT bit (TMR2CN.3) defines the Timer 2 operation mode. Timer 2 can also be used in Capture Mode to measure the RTC0 clock frequency or the External Oscillator clock frequency.

Timer 2 may be clocked by the system clock, the system clock divided by 12, or the external oscillator source divided by 8. The external oscillator source divided by 8 is synchronized with the system clock.

### 18.2.1. 16-bit Timer with Auto-Reload

When T2SPLIT (TMR2CN.3) is zero, Timer 2 operates as a 16-bit timer with auto-reload. Timer 2 can be clocked by SYSCLK, SYSCLK divided by 12, or the external oscillator clock source divided by 8. As the 16-bit timer register increments and overflows from 0xFFFF to 0x0000, the 16-bit value in the Timer 2 reload registers (TMR2RLH and TMR2RLL) is loaded into the Timer 2 register as shown in Figure 18.4, and the Timer 2 High Byte Overflow Flag (TMR2CN.7) is set. If Timer 2 interrupts are enabled (if IE.5 is set), an interrupt will be generated on each Timer 2 overflow. Additionally, if Timer 2 interrupts are enabled and the TF2LEN bit is set (TMR2CN.5), an interrupt will be generated each time the lower 8 bits (TMR2L) overflow from 0xFF to 0x00.

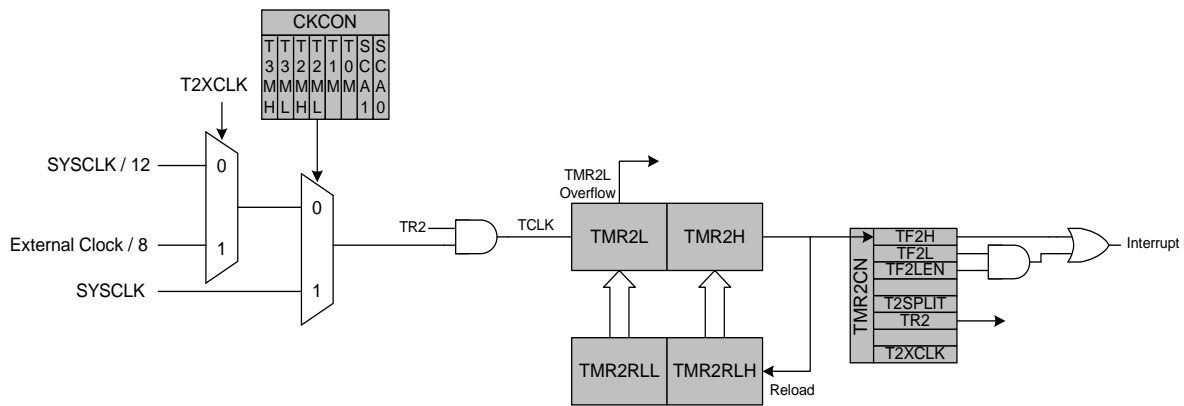


Figure 18.4. Timer 2 16-Bit Mode Block Diagram



# C8051F52x/F52xA/F53x/F53xA

## SFR Definition 19.3. PCA0CPMn: PCA Capture/Compare Mode

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
PWM16n	ECOMn	CAPPn	CAPNn	MATn	TOGn	PWMn	ECCFn	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: PCA0CPM0: 0xDA, PCA0CPM1: 0xDB, PCA0CPM2: 0xDC

**Bit7: PWM16n:** 16-bit Pulse Width Modulation Enable.  
This bit selects 16-bit mode when Pulse Width Modulation mode is enabled (PWMn = 1).  
0: 8-bit PWM selected.  
1: 16-bit PWM selected.

**Bit6: ECOMn:** Comparator Function Enable.  
This bit enables/disables the comparator function for PCA module n.  
0: Disabled.  
1: Enabled.

**Bit5: CAPPn:** Capture Positive Function Enable.  
This bit enables/disables the positive edge capture for PCA module n.  
0: Disabled.  
1: Enabled.

**Bit4: CAPNn:** Capture Negative Function Enable.  
This bit enables/disables the negative edge capture for PCA module n.  
0: Disabled.  
1: Enabled.

**Bit3: MATn:** Match Function Enable.  
This bit enables/disables the match function for PCA module n. When enabled, matches of the PCA counter with a module's capture/compare register cause the CCFn bit in PCA0MD register to be set to logic 1.  
0: Disabled.  
1: Enabled.

**Bit2: TOGn:** Toggle Function Enable.  
This bit enables/disables the toggle function for PCA module n. When enabled, matches of the PCA counter with a module's capture/compare register cause the logic level on the CEXn pin to toggle. If the PWMn bit is also set to logic 1, the module operates in Frequency Output Mode.  
0: Disabled.  
1: Enabled.

**Bit1: PWMn:** Pulse Width Modulation Mode Enable.  
This bit enables/disables the PWM function for PCA module n. When enabled, a pulse width modulated signal is output on the CEXn pin. 8-bit PWM is used if PWM16n is cleared; 16-bit mode is used if PWM16n is set to logic 1. If the TOGn bit is also set, the module operates in Frequency Output Mode.  
0: Disabled.  
1: Enabled.

**Bit0: ECCFn:** Capture/Compare Flag Interrupt Enable.  
This bit sets the masking of the Capture/Compare Flag (CCFn) interrupt.  
0: Disable CCFn interrupts.  
1: Enable a Capture/Compare Flag interrupt request when CCFn is set.

# C8051F52x/F52xA/F53x/F53xA

## SFR Definition 19.4. PCA0L: PCA Counter/Timer Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xF9

**Bits7–0: PCA0L:** PCA Counter/Timer Low Byte.  
The PCA0L register holds the low byte (LSB) of the 16-bit PCA Counter/Timer.

## SFR Definition 19.5. PCA0H: PCA Counter/Timer High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xFA

**Bits7–0: PCA0H:** PCA Counter/Timer High Byte.  
The PCA0H register holds the high byte (MSB) of the 16-bit PCA Counter/Timer.

## SFR Definition 19.6. PCA0CPLn: PCA Capture Module Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: PCA0CPL0: 0xFB, PCA0CPL1: 0xE9, PCA0CPL2: 0xEB

**Bits7–0: PCA0CPLn:** PCA Capture Module Low Byte.  
The PCA0CPLn register holds the low byte (LSB) of the 16-bit capture module n.

## SFR Definition 19.7. PCA0CPHn: PCA Capture Module High Byte

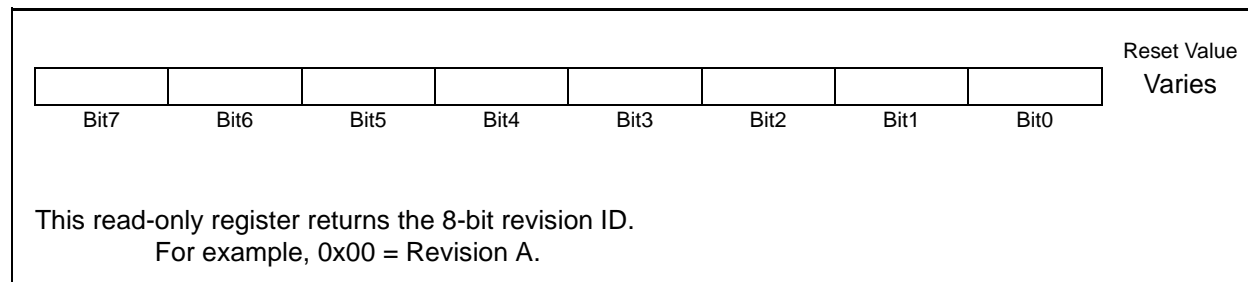
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: PCA0CPH0: 0xFC, PCA0CPH1: 0xE9, PCA0CPH2: 0xEC

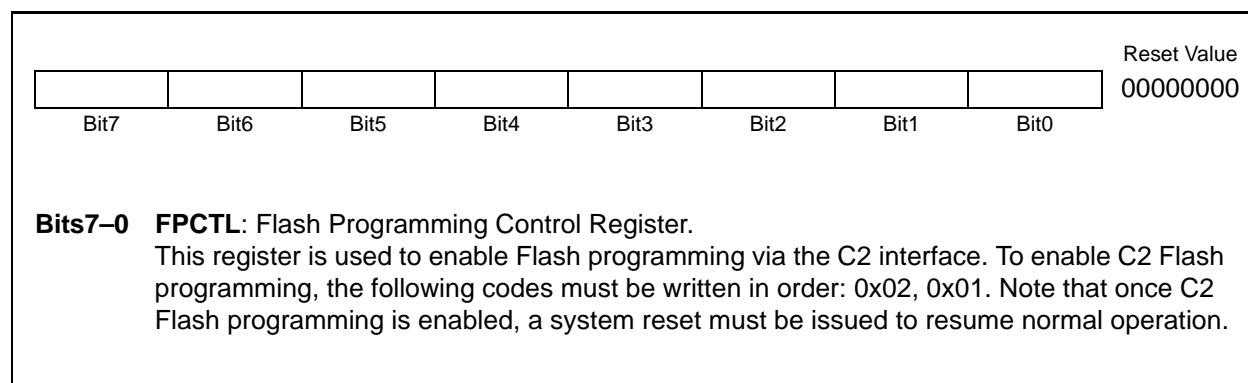
**Bits7–0: PCA0CPHn:** PCA Capture Module High Byte.  
The PCA0CPHn register holds the high byte (MSB) of the 16-bit capture module n.

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## C2 Register Definition 21.3. REVID: C2 Revision ID



## C2 Register Definition 21.4. FPCTL: C2 Flash Programming Control



## C2 Register Definition 21.5. FPDAT: C2 Flash Programming Data

